

ST8812FX

High voltage fast-switching NPN Power transistor

Features

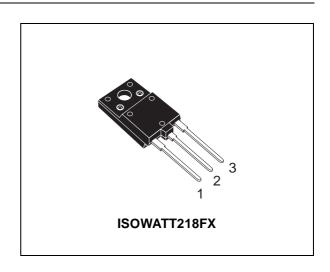
- High voltage capability
- Very high switching speed
- Tight hfe control
- Large R.B.S.O.A.
- Fully insulated Package U.L. compliant for easy mounting

Applications

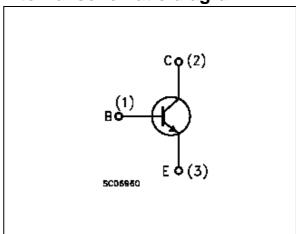
■ Switch mode power supplies for crt TV

Description

The ST8812FX is manufactured using latest Multi Epitaxial Planar technology with high voltage capability. It shows wide R.B.S.O.A. and high switching speed thanks to its Cellular Emitter structure with planar edge termination and deep base diffusion.



Internal schematic diagram



Order codes

Part Number	Marking	Package	Packing
ST8812FX	ST8812FX	ISOWATT218FX	TUBE

Electrical ratings ST8812FX

1 Electrical ratings

Table 1. Absolute maximum rating

Symbol	Parameter	Value	Unit
V _{CBO}	Collector-Base Voltage (I _E = 0)	1150	V
V _{CEO}	Collector-Emitter Voltage (I _B = 0)	600	V
V _{EBO}	Emitte-Base Voltage (I _C = 0)	15	V
I _C	Collector Current	7	Α
I _{CM}	Collector Peak Current (t _P < 5ms)	12	Α
I _B	Base Current	4	Α
P _{TOT}	Total dissipation at T _c = 25°C	50	W
V _{isol}	Insulation Withstand Voltage (RMS) from All Three Leads to External Heatsink	2500	V
T _{STG}	Storage Temperature	-65 to 150	°C
TJ	Max. Operating Junction Temperature	150	°C

Table 2. Thermal data

Symbol	Parameter	Value	Unit
R _{thJ-case}	Thermal Resistance Junction-Case Max	2.5	°C/W

ST8812FX Electrical characteristics

2 Electrical characteristics

(T_{CASE} = 25°C; unless otherwise specified)

Table 3. Electrical characteristics

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
I _{CES}	Collector Cut-off Current (V _{BE} = 0)	V _{CE} = 1150V V _{CE} = 1150V	T _c = 125°C			1 2	mA mA
I _{EBO}	Emitter Cut-off Current (I _C = 0)	V _{EB} = 14V				1	mA
V _{CEO(sus)} Note: 1	Collector-Emitter Sustaining Voltage (I _B = 0)	I _C = 100mA		600			V
V _{CE(sat)} Note: 1	Collector-Emitter Saturation Voltage	$I_C = 4A$ $I_C = 4A$	$I_{B} = 0.8A$ $I_{B} = 1.2A$			3 1.5	V V
V _{BE(sat)} Note: 1	Base-Emitter Saturation Voltage	I _C = 4A	$I_{B} = 0.8A$			1.3	V
h _{FE}	DC Current Gain	$I_{C} = 1A$ $I_{C} = 5A$ $I_{C} = 5A$	$V_{CE} = 5V$ $V_{CE} = 1V$ $V_{CE} = 5V$		25 5	9	
t _s	INDUCTIVE LOAD Storage Time Fall Time	$I_C = 4A$ $V_{Clamp} = 480V$ $I_{B1} = 0.8A$ (See <i>Figure 8</i>)	` '		1 60	1.6 120	μs ns

Note: 1 Pulsed duration = 300 µs, duty cycle ≤1.5%.

Electrical characteristics ST8812FX

2.1 Typical characteristics test circuit

Figure 1. DC current gain

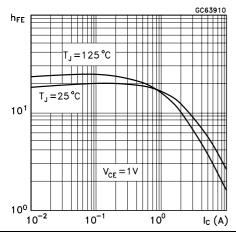


Figure 2. DC current gain

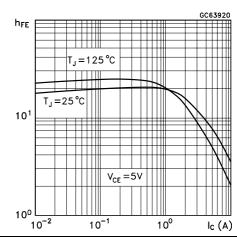
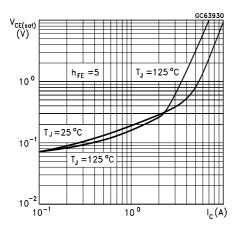


Figure 3. Collector emitter saturation voltage Figure 4. Base emitter saturation voltage



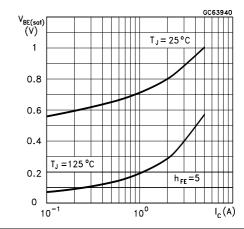
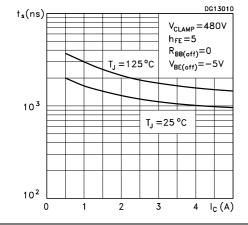
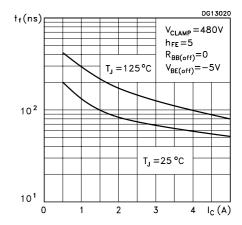


Figure 5. Inductive load storage time

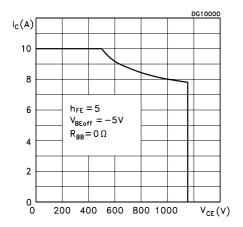
Figure 6. Inductive load fall time





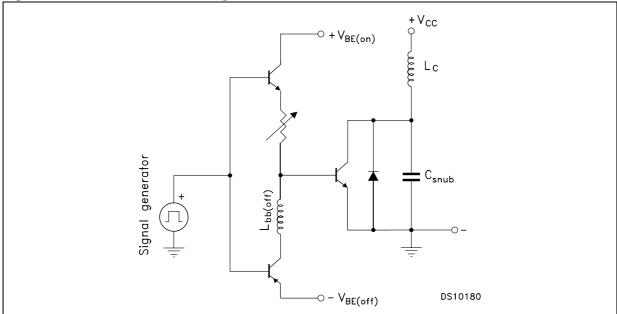
ST8812FX Electrical characteristics

Figure 7. Reverse biased S.O.A.



Electrical characteristics ST8812FX

Figure 8. Inductive load switching test circuit



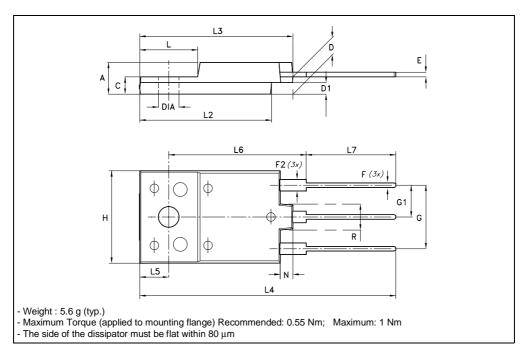
3 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

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ISOWATT218FX MECHANICAL DATA

DIM.	mm			inch			
DIN.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
Α	5.30		5.70	0.209		0.224	
С	2.80		3.20	0.110		0.126	
D	3.10		3.50	0.122		0.138	
D1	1.80		2.20	0.071		0.087	
E	0.80		1.10	0.031		0.043	
F	0.65		0.95	0.026		0.037	
F2	1.80		2.20	0.071		0.087	
G	10.30		11.50	0.406		0.453	
G1		5.45			0.215		
Н	15.30		15.70	0.602		0.618	
L	9.0		10.20	0.354		0.402	
L2	22.80		23.20	0.898		0.913	
L3	26.30		26.70	1.035		1.051	
L4	43.20		44.40	1.701		1.748	
L5	4.30		4.70	0.169		0.185	
L6	24.30		24.70	0.957		0.972	
L7	14.60	•	15.00	0.575		0.591	
N	1.80		2.20	0.071		0.087	
R	3.80	•	4.20	0.150		0.165	
DIA	3.40		3.80	0.134		0.150	



ST8812FX Revision History

4 Revision History

Table 4. Revision history

Date	Revision	Changes
23-Feb-2006	1	Initial release.

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